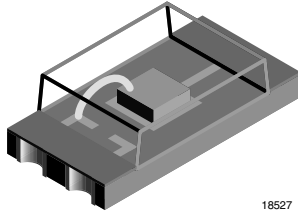


## Ambient Light Sensor, RoHS Compliant, Released for Lead (Pb)-free Reflow Soldering, AEC-Q101 Released



18527

### DESCRIPTION

TEMD6010FX01 ambient light sensor is a PIN photodiode with high speed and high photo sensitivity in a clear, surface mount plastic package. The detector chip has 0.23 mm<sup>2</sup> sensitive area. It is sensitive to visible light much like the human eye and has peak sensitivity at 540 nm.

### FEATURES

- Package type: surface mount
- Package form: 1206
- Dimensions (L x W x H in mm): 4 x 2 x 1.05
- Radiant sensitive area (in mm<sup>2</sup>): 0.23
- Product designed and qualified acc. AEC-Q101 for the automotive market
- High photo sensitivity
- Adapted to human eye responsivity
- Supression filter for near infrared radiation
- Angle of half sensitivity:  $\varphi = \pm 60^\circ$
- Floor life: 72 h, MSL 4, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Lead (Pb)-free component in accordance with RoHS 2002/95/EC and WEEE 2002/96/EC


**RoHS  
COMPLIANT**

### APPLICATIONS

- Automotive sensors
- Ambient light sensors
- Backlight dimming
- Mobil phones
- Notebooks
- Computers

### PRODUCT SUMMARY

COMPONENT	$I_{ra}$ ( $\mu A$ )	$\varphi$ (deg)	$\lambda_{0.5}$ (nm)
TEMD6010FX01	1	$\pm 60$	430 to 610

**Note**

Test conditions see table "Basic Characteristics"

### ORDERING INFORMATION

ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
TEMD6010FX01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	1206

**Note**

MOQ: minimum order quantity

### ABSOLUTE MAXIMUM RATINGS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage		$V_R$	16	V
Power dissipation		$P_V$	100	mW
Junction temperature		$T_j$	100	$^\circ C$
Operating temperature range		$T_{amb}$	- 40 to + 100	$^\circ C$
Storage temperature range		$T_{stg}$	- 40 to + 100	$^\circ C$
Soldering temperature	Acc. reflow solder profile fig. 7	$T_{sd}$	260	$^\circ C$
Thermal resistance junction/ambient	Soldered on PCB with pad dimensions: 4 mm x 4 mm	$R_{thJA}$	450	K/W

**Note**
 $T_{amb} = 25^\circ C$ , unless otherwise specified

BASIC CHARACTERISTICS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Breakdown voltage	$I_R = 100 \mu\text{A}, E = 0$	$V_{(BR)}$	16			V
Reverse dark current	$V_{CE} = 5 \text{ V}, E = 0$	$I_{ro}$		2	30	nA
Diode capacitance	$V_R = 0 \text{ V}, f = 1 \text{ MHz}, E = 0$	$C_D$		60		pF
	$V_R = 5 \text{ V}, f = 1 \text{ MHz}, E = 0$	$C_D$		24		pF
Reverse light current	$E_e = 1 \text{ mW/cm}^2, \lambda = 550 \text{ nm}, V_R = 5 \text{ V}$	$I_{ra}$		1		$\mu\text{A}$
	$E_V = 100 \text{ lx}, \text{CIE illuminant A}, V_R = 5 \text{ V}$	$I_{ra}$	0.03	0.04		$\mu\text{A}$
Temperature coefficient of $I_{ra}$	$E_V = 100 \text{ lx}, \text{CIE illuminant A}, V_R = 5 \text{ V}$	$TK_{I_{ra}}$		0.2		%/K
Angle of half sensitivity		$\phi$		$\pm 60$		deg
Wavelength of peak sensitivity		$\lambda_p$		540		nm
Range of spectral bandwidth		$\lambda_{0.5}$		430 to 610		nm

**Note**

$T_{amb} = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

**BASIC CHARACTERISTICS**

$T_{amb} = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

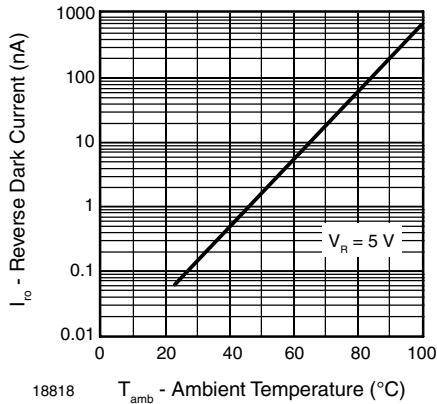


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

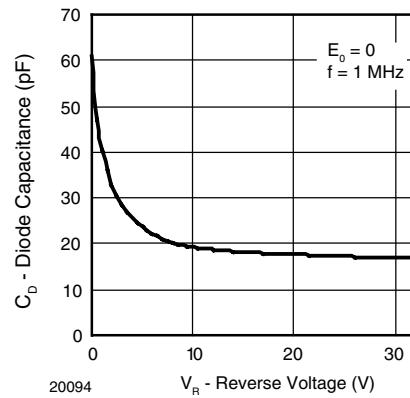


Fig. 3 - Diode Capacitance vs. Reverse Voltage

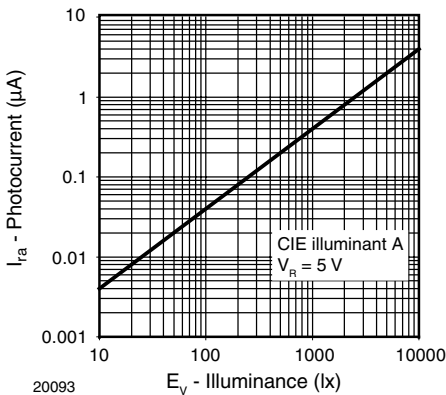


Fig. 2 - Reverse Light Current vs. Illuminance

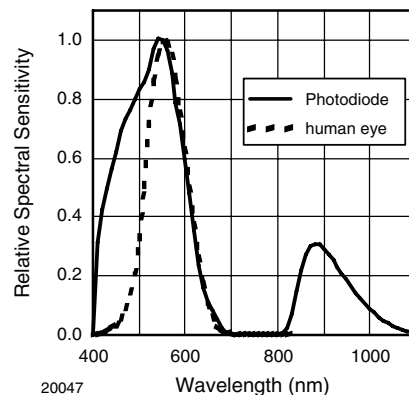


Fig. 4 - Relative Spectral Sensitivity vs. Wavelength

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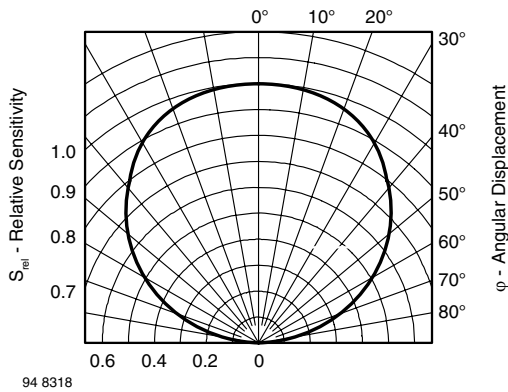


Fig. 5 - Relative Radiant Sensitivity vs. Angular Displacement

## REFLOW SOLDER PROFILE

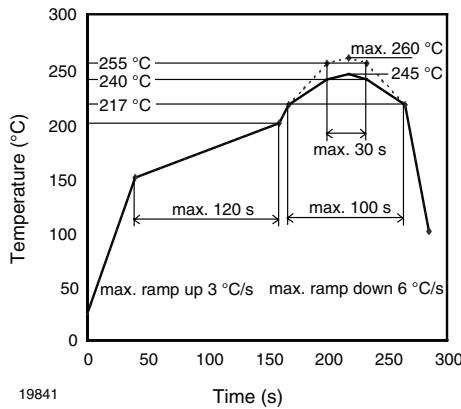
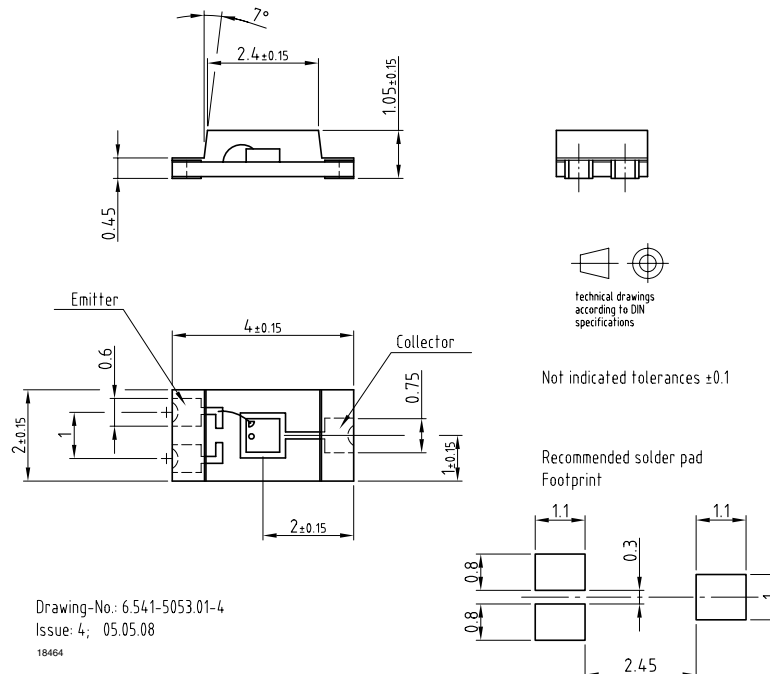


Fig. 6 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020D

## PACKAGE DIMENSIONS in millimeters



## DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

## FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 4

Floor life: 72 h

Conditions:  $T_{amb} < 30\text{ }^{\circ}\text{C}$ ,  $RH < 60\%$

## DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or recommended conditions:

192 h at  $40\text{ }^{\circ}\text{C}$  (+  $5\text{ }^{\circ}\text{C}$ ),  $RH < 5\%$

or

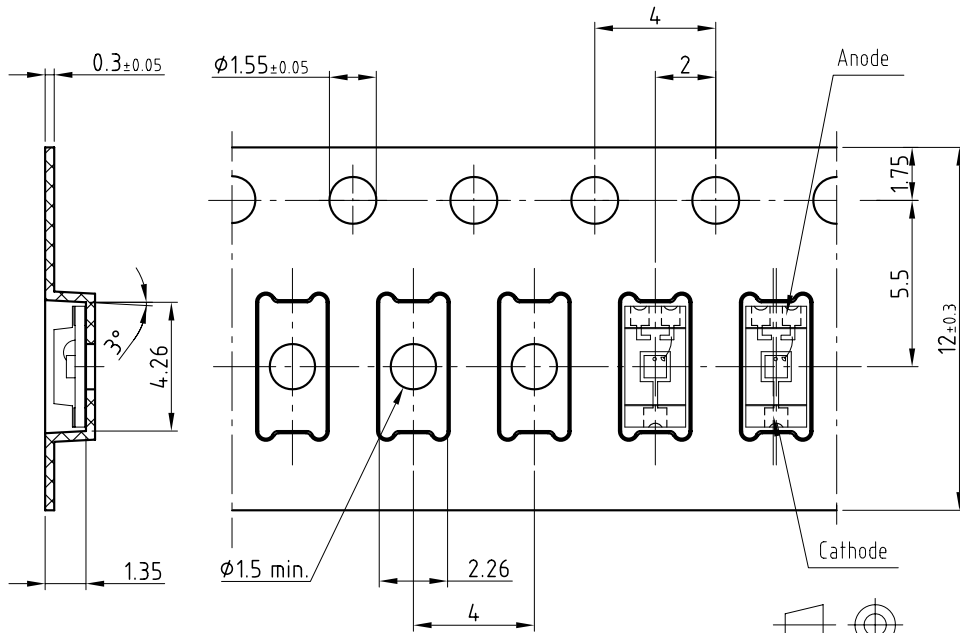
96 h at  $60\text{ }^{\circ}\text{C}$  (+  $5\text{ }^{\circ}\text{C}$ ),  $RH < 5\%$ .

# TEMD6010FX01



Vishay Semiconductors Ambient Light Sensor, RoHS Compliant,  
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## BLISTER TAPE DIMENSIONS in millimeters



Drawing-No.: 9.700-5329.02-4  
Issue: 1; 05.05.08  
20877

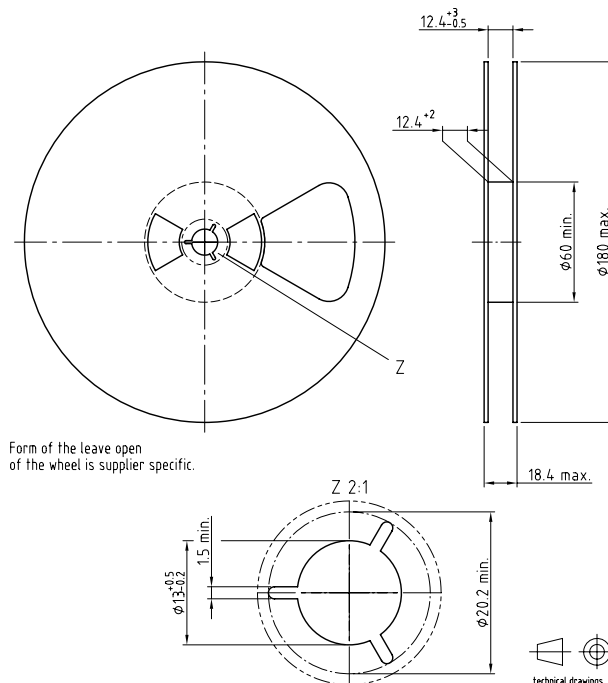
Reel off direction  
→

technical drawings  
according to DIN  
specifications

Not indicated tolerances ±0.1

## REEL DIMENSIONS in millimeters

Volume: 3000 pcs/reel



Form of the leave open  
of the wheel is supplier specific.

Drawing-No.: 9.800-5097.01-4  
Issue: 1; 05.05.08  
20874

technical drawings  
according to DIN  
specifications



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